2SC4953

Silicon NPN triple diffusion planar type

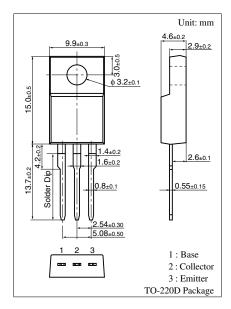
For high breakdown voltage high-speed switching

Features

- High-speed switching
- \bullet High collector to base voltage V_{CBO}
- Wide area of safe operation (ASO)
- \bullet Satisfactory linearity of forward current transfer ratio h_{FE}
- Dielectric breakdown voltage of the package: > 5 kV

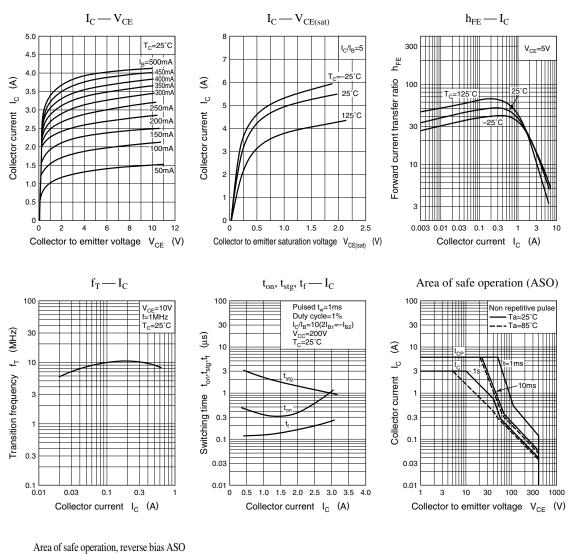
Parameter		Symbol	Rating	Unit
Collector to base voltage		V _{CBO}	500	V
Collector to emitter voltage		V _{CES}	500	V
		V _{CEO}	400	V
Emitter to base voltage		V _{EBO}	7	V
Peak collector current		I _{CP}	6	А
Collector current		I _C	3	А
Base current		IB	1.2	А
Collector power	$T_C = 25^{\circ}C$	P _C	30	W
dissipation	$T_a = 25^{\circ}C$		2.0	
Junction temperature		Tj	150	°C
Storage temperature		T _{stg}	-55 to +150	°C

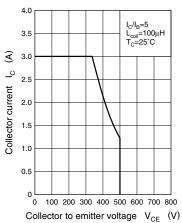
Absolute Maximum Ratings $T_C = 25^{\circ}C$



Electrical Characteristics $T_C = 25^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 500 \text{ V}, I_E = 0$			100	μΑ
Emitter cutoff current	I _{EBO}	$V_{EB} = 5 V, I_C = 0$			100	μΑ
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 0$	400			v
Forward current transfer ratio	h _{FE1}	$V_{CE} = 5 V, I_C = 0.1 A$	10			
	h _{FE2}	$V_{CE} = 2 V, I_C = 1.2 A$	8		40	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 1.5 \text{ A}, I_{\rm B} = 0.3 \text{ A}$			1.0	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_{\rm C} = 1.5 \text{ A}, I_{\rm B} = 0.3 \text{ A}$			1.5	v
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_C = 0.2 \text{ A}, f = 1 \text{ MHz}$		10		MHz
Turn-on time	t _{on}	$I_{C} = 1.5 \text{ A}, I_{B1} = 0.15 \text{ A}, I_{B2} = -0.3 \text{ A},$			1.0	μs
Storage time	t _{stg}	$V_{CC} = 200 V$			3.0	μs
Fall time	t _f				0.3	μs





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